## **MMVL409T1**

**Preferred Device** 

# **Silicon Tuning Diode**

These devices are designed for general frequency control and tuning applications. They provide solid-state reliability in replacement of mechanical tuning methods.

#### **Features**

- High Q with Guaranteed Minimum Values at VHF Frequencies
- Controlled and Uniform Tuning Ratio
- Surface Mount Package
- Pb-Free Package is Available

### **MAXIMUM RATINGS**

Rating	Symbol	Value	Unit
Continuous Reverse Voltage	V <sub>R</sub>	20	Vdc
Peak Forward Current	lF	200	mAdc

#### THERMAL CHARACTERISTICS

Characteristic	Symbol	Max	Unit
Total Device Dissipation FR–5 Board, T <sub>A</sub> = 25°C (Note 1) Derate above 25°C	P <sub>D</sub>	200 1.57	mW mW/°C
Thermal Resistance, Junction-to-Ambient	$R_{\theta JA}$	635	°C/W
Junction and Storage Temperature	T <sub>J</sub> , T <sub>stg</sub>	150	°C

Maximum ratings are those values beyond which device damage can occur. Maximum ratings applied to the device are individual stress limit values (not normal operating conditions) and are not valid simultaneously. If these limits are exceeded, device functional operation is not implied, damage may occur and reliability may be affected.

1. FR-4 Minimum Pad



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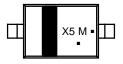
### **VOLTAGE VARIABLE** CAPACITANCE DIODE





**PLASTIC** SOD-323 **CASE 477** STYLE 1

### **MARKING DIAGRAM**



= Device Code = Date Code\*

= Pb-Free Package

(Note: Microdot may be in either location) \*Date Code orientation may vary depending upon manufacturing location.

### **ORDERING INFORMATION**

Device	Package	Shipping <sup>†</sup>
MMVL409T1	SOD-323	3000 / Tape & Reel
MMVL409T1G	SOD-323 (Pb-Free)	3000 / Tape & Reel

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

Preferred devices are recommended choices for future use and best overall value.

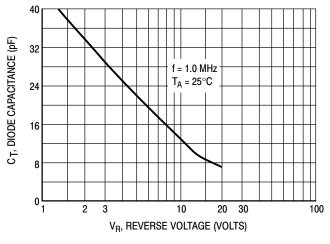
### **ELECTRICAL CHARACTERISTICS** (T<sub>A</sub> = 25°C unless otherwise noted)

Characteristic	Symbol	Min	Тур	Max	Unit
Reverse Breakdown Voltage $(I_R = 10 \mu Adc)$	$V_{(BR)R}$	20	-	-	Vdc
Reverse Voltage Leakage Current (V <sub>R</sub> = 15 Vdc)	I <sub>R</sub>	-	-	0.1	μAdc
Diode Capacitance Temperature Coefficient (V <sub>R</sub> = 3.0 Vdc, f = 1.0 MHz)	TC <sub>C</sub>	-	300	-	ppm/°C

	C <sub>t</sub> , Diode Capacitance V <sub>R</sub> = 3.0 Vdc, f = 1.0 MHz pF		Q, Figure of Merit V <sub>R</sub> = 3.0 Vdc f = 50 MHz	C <sub>R</sub> , Capacitance Ratio C <sub>3</sub> /C <sub>8</sub> (Note 2) f = 1.0 MHz		
Device	Min	Nom	Max	Min	Min	Max
MMVL409T1	26	29	32	200	1.5	1.9

<sup>2.</sup>  $C_R$  is the ratio of  $C_t$  measured at 3 Vdc divided by  $C_t$  measured at 8 Vdc.

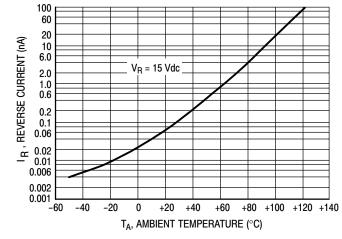
### **TYPICAL CHARACTERISTICS**



1000 V<sub>R</sub> = 3 Vdc T<sub>A</sub> = 25°C

Figure 1. Diode Capacitance

Figure 2. Figure of Merit



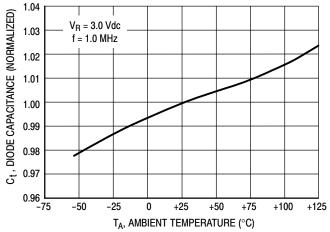


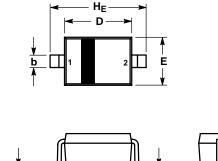
Figure 3. Leakage Current

Figure 4. Diode Capacitance

#### MMVL409T1

### PACKAGE DIMENSIONS

SOD-323 CASE 477-02 ISSUE G





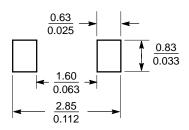
#### NOTES:

- DIMENSIONING AND TOLERANCING PER ANSI
   V14 FM 1082
- Y14.5M, 1982.
  2. CONTROLLING DIMENSION: MILLIMETERS.
- LEAD THICKNESS SPECIFIED PER L/F DRAWING WITH SOLDER PLATING.
- DIMENSIONS A AND B DO NOT INCLUDE MOLD FLASH, PROTRUSIONS OR GATE BURRS.
- DIMENSION L IS MEASURED FROM END OF RADIUS.

	MIL	MILLIMETERS			INCHES			
DIM	MIN	NOM	MAX	MIN	NOM	MAX		
Α	0.80	0.90	1.00	0.031	0.035	0.040		
A1	0.00	0.05	0.10	0.000	0.002	0.004		
A3	0.15 REF			0.006 REF				
b	0.25	0.32	0.4	0.010	0.012	0.016		
С	0.089	0.12	0.177	0.003	0.005	0.007		
D	1.60	1.70	1.80	0.062	0.066	0.070		
Е	1.15	1.25	1.35	0.045	0.049	0.053		
L	0.08			0.003				
HE	2.30	2.50	2.70	0.090	0.098	0.105		

STYLE 1: PIN 1. CATHODE 2. ANODE

### **SOLDERING FOOTPRINT\***



\*For additional information on our Pb–Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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MMVL409T1/D